504367484 05/15/2017

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
BYUNG JIN CHOI	03/22/2017
JAE HYUN LEE	03/22/2017

RECEIVING PARTY DATA

Name:	DONGWOO FINE-CHEM CO., LTD.		
Street Address:	Street Address: 132, YAKCHON-RO, IKSAN-SI		
City:	JEOLLABUK-DO		
State/Country:	KOREA, REPUBLIC OF		
Postal Code: 54631			

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	15475733	

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: andrea.borden@dlapiper.com

Correspondent Name: JEFFREY S. CLARK

Address Line 1: DLA PIPER

Address Line 2: 33 ARCH STREET, 26TH FL

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ATTORNEY DOCKET NUMBER:	DAR-004	
NAME OF SUBMITTER:	JEFFREY S. CLARK	
SIGNATURE:	/Jeffrey S. Clark/	
DATE SIGNED:	05/15/2017	

Total Attachments: 2

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PATENT 504367484 REEL: 042380 FRAME: 0678

Attorney Docket No. DAR-004

ASSIGNMENT

WHEREAS, We, Byung Jin Choi and Jae Hyun Lee, have invented one or more inventions described in an application (or provisional application) for Letters Patent of the United States entitled:

"TOUCH SENSOR"

and identified by

Application No. 15/475,733 filed in the U.S. Patent and Trademark Office on March 31, 2017; and

WHEREAS, DONGWOO FINE-CHEM CO., LTD. (hereinafter "ASSIGNEE"), having a usual place of business at 132, Yakchon-ro, Iksan-si, Jeollabuk-do 54631, Republic of Korea Republic of Korea, desires to acquire an interest therein, in accordance with agreements duly entered into with me;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, at least as early as the filing date of said application, our entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to the invention(s) described in said application, together with our entire right, title and interest in and to said application, and such Letters Patent that may issue thereon and applications that claim priority thereto under United States law or international convention, and such Letters Patent that may issue thereon, including but not limited to non-U.S., international, non-provisional, continuation, divisional, reissue, reexamination, extension, and substitution applications of said application and such Letters Patent, and any right, title and interest we may have in provisional applications to which said application claims priority; said invention(s), applications and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey all of our rights arising under or pursuant to any and all United States laws and international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent, including but not limited to any cause(s) of action and damages accruing prior to this assignment. We hereby acknowledge that this assignment, being of our entire right, title and interest in and to said invention(s), carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all Letters Patent to ASSIGNEE in its own name as assignee of our entire right, title and interest therein;

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PATENT REEL: 042380 FRAME: 0679 Assignment U.S. Application No. 15/475,733 Page 2 of 2

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention(s) to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of papers for filing of non-provisional, substitution, continuation, divisional, reissue, reexamination, and corresponding foreign and international patent applications;

AND, we hereby further agree to provide statements or testimony in any interference or other proceeding in which said invention(s) or any application or patent directed thereto may be involved;

AND, we hereby authorize ASSIGNEE or its attorneys or agents to insert the correct serial number and filing date into this assignment, if none is indicated on the date of our execution of this assignment;

AND, we do hereby authorize and request the Director of the United States Patent and Trademark Office and the empowered officials of all other governments to issue such Letters Patent as shall be granted upon said application, or applications based thereon, to said ASSIGNEE, its successors, assigns or legal representatives.

	TESTIMONY WHEREOF,	we have hereun	to set my hand and	affixed my seal on the
date set fo	Byung Jin Choi	_ Witness:_	Soeun Jang	Date:Date:
Inventor_	Jae Hynn Lee	_ Witness:_	Soeun Jang	Date: Warch 22, 2017

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